



PATENT

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September 14, 2001

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Whonchee Lee, Scott G. Meikle, Scott E. Moore and  
Trung T. Doan

Application No. : 09/888,084

Filed : June 21, 2001

For : METHODS AND APPARATUS FOR ELECTRICAL,  
MECHANICAL AND/OR CHEMICAL REMOVAL OF  
CONDUCTIVE MATERIAL FROM A MICROELECTRONIC  
SUBSTRATE

Docket No. : 108298515US1

Date : September 14, 2001

Commissioner for Patents  
Washington, DC 20231

PRELIMINARY AMENDMENT

Dear Commissioner:

In keeping with 37 C.F.R. § 1.121, this paper includes a clean version of the amended specification paragraph. An appendix is attached showing the marked-up version of the specification paragraph amended in the present response. Please amend the application as follows and reconsider the application in light of the following remarks.

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